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3	BRS	L3	244	1 and (cure same (temperature or degrees or degree))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/19 08:43		0
4	IS&R	L4	3	("5384376").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/19 09:28		0
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3	BRS	L3	22	2 and (FET or (field adj effect adj transistor))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/18 11:21		0
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7	BRS	L7	178	5 not 6	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/18 12:38		0
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File: JPAB

Aug 18, 1992

PUB-NO: JP404228415A

DOCUMENT-IDENTIFIER: JP 04228415 A

TITLE: METHOD FOR CONVERTING SILICA PRECURSOR INTO SILICA AT LOW TEMPERATURE BY USING AMINE CATALYST

PUBN-DATE: August 18, 1992

INVENTOR-INFORMATION:

NAME

COUNTRY

BANEY, RONALD HOWARD

BILGRIEN, CARL J

BRODERICK, DENNIS W

CARPENTER, LESLIE EARL

ASSIGNEE-INFORMATION:

NAME

COUNTRY

DOW CORNING CORP

APPL-NO: JP03130982

APPL-DATE: June 3, 1991

INT-CL (IPC): C01B 33/12; B01J 6/00; C04B 41/50; C09D 183/02; C09D 183/04

ABSTRACT:

PURPOSE: To provide the method for converting hydrogen silsesquioxane resin or hydrolyzed or partially hydrolyzed R

CONSTITUTION: This converting method comprises a process (1) for coating a base with a silica precursor coating, a process (2) for exposing the coating to an atmosphere containing amine, and a process (3) for applying sufficient heat for the formation of the ceramic coating to the coating.

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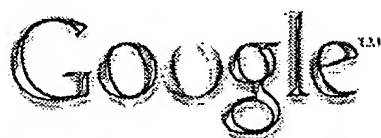
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